

Uni-Royal

DATASHEET

Product Name **High-Power Thick Film Chip Resistors**

Part Name **HP Series**

File No. **SMD-SP-003**

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1. Scope

- 1.1 This datasheet is the characteristics of High Power Thick Film Chip Resistors manufactured by UNI-ROYAL.
- 1.2 High power standard size
- 1.3 Suitable for both wave & re-flow soldering
- 1.4 AEC-Q200 qualified
- 1.5 Application: AV adapters, LCD back-light, camera strobe ect.
- 1.6 Compliant with RoHS directive.
- 1.7 Halogen free requirement.

2. Part No. System

Part No. includes 14 codes shown as below:

2.1 1st~4th codes: Part name. E.g.: HP02、HP03、HP05、HP06、HP07、HP10、HP11、HP12
2.2 5th~6th codes: Power rating.

E.g.: W=Normal Size		“1~G” = “1~16”						
Wattage	3/4	1/2	1/3	1/5	1/10	1	1.25	2
Normal Size	07	W2	W3	W5	WA	1W	1Q	2W

If power rating is equal or lower than 1 watt, 5th code would be "W" and 6th code would be a number or letter.

E.g.: $WA = 1/10W$ $W3 = 1/3W$

2.3 7th code: Tolerance. E.g.: D= $\pm 0.5\%$ F= $\pm 1\%$ J= $\pm 5\%$

2.4 8th~11th codes: Resistance Value.

2.4.1 If value belongs to standard value of E-24 series, the 8th code is zero, 9th~10th codes are the significant figures of resistance value, and the 11th code is the power of ten.

2.4.2 If value belongs to standard value of E-96 series, the 8th~10th codes are the significant figures of resistance value, and the 11th code is the power of ten.

2.4.3 11th codes listed as following:

codes listed as following:

25 12th~14th codes

2.5.1 12th code: Packaging Type E.g.: T=Tape/Reel

2.5.2 13th code: Standard Packing Quantity

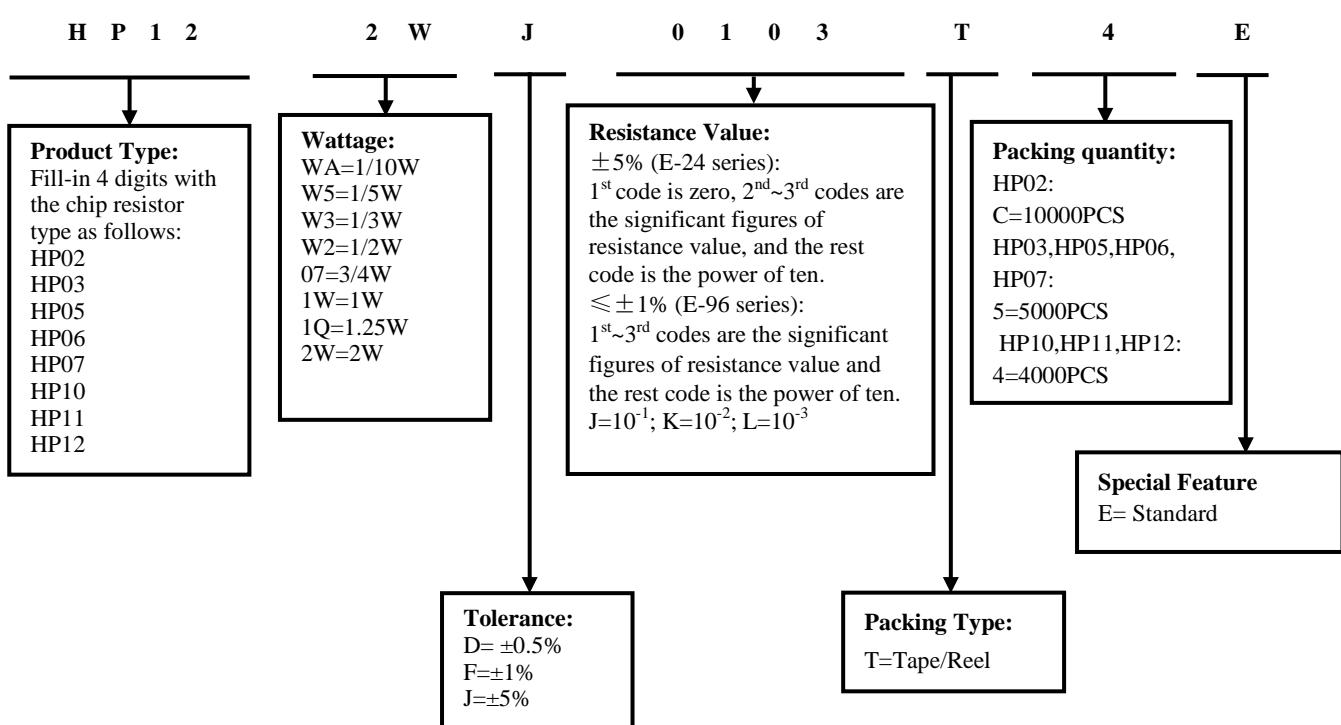
Standard Packing Quantity:
A=4,000pcs B=5,000pcs C=10,000pcs

2.5.3 14th code: Special features

14 Code. Spec

3 Ordering Procedure

(Example: HP12 2W ±5% 10KΩ T/R-4000)



4. Marking

4.1 For HP02 size. Due to the very small size of the resistor's body, there is no marking on the body.



4.2 Normally, the marking of 0Ω HP03, 0Ω HP05, 0Ω HP06, 0Ω HP07, 0Ω HP10, 0Ω HP11, 0Ω HP12 resistors as following



0 → 0Ω

4.3 ±5% tolerance products (E-24 series):

3 codes.

1st~2nd codes are the significant figures of resistance value, and the rest code is the power of ten.



333 → 33KΩ

4.4 ±0.5%, ±1% tolerance products (E-96 series):

4 codes.

1st~3rd codes are the significant figures of resistance value, and the rest code is the power of ten.



2701 → 2.7KΩ

4.5 More than HP05 specifications (including) 4 digits, Product below 1Ω, show as following, the first digit Is "R" which as decimal point.



R300 → 0.3Ω

4.6 Standard E-96 series values of HP03 $\leq\pm1\%$: due to the small size of the resistor's body, 3 digits marking will be used to indicate the accurate resistance value by using the following multiplier & resistance code.

Multiplier Code (for HP03 $\leq\pm1\%$ marking)

Code	A	B	C	D	E	F	G	H	X	Y	Z
Multiplier	10^0	10^1	10^2	10^3	10^4	10^5	10^6	10^7	10^{-1}	10^{-2}	10^{-3}

Standard E-96 series Resistance Value code (for HP03 $\leq\pm1\%$ marking)

Value	Code	Value	Code	Value	Code	Value	Code
100	01	178	25	316	49	562	73
102	02	182	26	324	50	576	74
105	03	187	27	332	51	590	75
107	04	191	28	340	52	604	76
110	05	196	29	348	53	619	77
113	06	200	30	357	54	634	78
115	07	205	31	365	55	649	79
118	08	210	32	374	56	665	80
121	09	215	33	383	57	681	81
124	10	221	34	392	58	698	82
127	11	226	35	402	59	715	83
130	12	232	36	412	60	732	84
133	13	237	37	422	61	750	85
137	14	243	38	432	62	768	86
140	15	249	39	442	63	787	87
143	16	255	40	453	64	806	88
147	17	261	41	464	65	825	89
150	18	267	42	475	66	845	90
154	19	274	43	487	67	866	91
158	20	280	44	499	68	887	92
162	21	287	45	511	69	909	93
165	22	294	46	523	70	931	94
169	23	301	47	536	71	953	95
174	24	309	48	549	72	976	96

So the resistance value are marked as the following examples



$1.96\text{K}\Omega = 196 \times 10^3 \Omega = 29\text{B}$



$12.4\Omega = 124 \times 10^{-3} \Omega = 10\text{X}$

4.7 Standard E-24 and not belong to E-96 series values ($\leq \pm 1\%$) of 0603 size: the marking is the same as 5% tolerance but marking as underline.



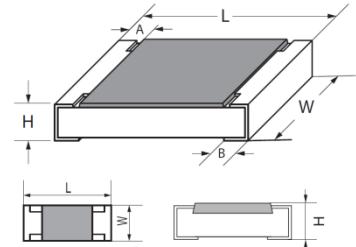
333 = $33\text{K}\Omega$



680 = 68Ω

5. Dimension

Type	Dimension(mm)				
	L	W	H	A	B
HP02(0402)	1.00 ± 0.10	0.50 ± 0.05	0.35 ± 0.05	0.20 ± 0.10	0.25 ± 0.10
HP03(0603)	1.60 ± 0.10	0.80 ± 0.10	0.45 ± 0.10	0.30 ± 0.20	0.30 ± 0.20
HP05(0805)	2.00 ± 0.15	$1.25 \pm 0.15 / -0.10$	0.55 ± 0.10	0.40 ± 0.20	0.40 ± 0.20
HP06(1206)	3.10 ± 0.15	$1.55 \pm 0.15 / -0.10$	0.55 ± 0.10	0.45 ± 0.20	0.45 ± 0.20
HP07(1210)	3.10 ± 0.10	2.50 ± 0.15	0.55 ± 0.10	0.50 ± 0.25	0.50 ± 0.20
HP10(2010)	5.00 ± 0.10	2.50 ± 0.20	0.55 ± 0.10	0.60 ± 0.25	0.50 ± 0.20
HP11(1812)	4.50 ± 0.20	3.20 ± 0.20	0.55 ± 0.20	0.50 ± 0.20	0.50 ± 0.20
HP12(2512)	6.35 ± 0.10	3.20 ± 0.20	0.55 ± 0.10	0.60 ± 0.25	0.50 ± 0.20



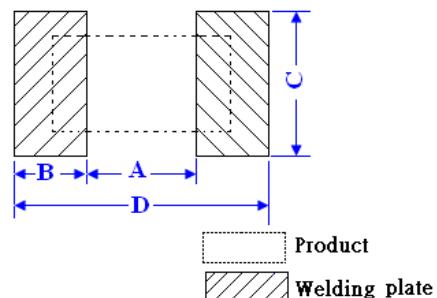
6. Resistance Range

Type	Power Rating	Resistance Range of 0.5%, 1%, 5%	Max. Working Voltage	Max. Overload Voltage	Dielectric withstandin Voltage	Operating Temperature
HP02(0402)	1/10W	$1\Omega \sim 10\text{M}\Omega$	50V	100V	100V	
HP03(0603)	1/5W	$0.1\Omega \sim 10\text{M}\Omega$	75V	150V	300V	
HP05(0805)	1/3W	$0.01\Omega \sim 10\text{M}\Omega$	150V	300V	500V	
HP06(1206)	1/2W	$0.01\Omega \sim 10\text{M}\Omega$	200V	400V	500V	
HP07(1210)	3/4W	$0.1\Omega \sim 10\text{M}\Omega$	200V	500V	500V	
HP10(2010)	1W	$0.01\Omega \sim 10\text{M}\Omega$	200V	500V	500V	
HP11(1812)	1.25W	$0.1\Omega \sim 10\text{M}\Omega$	200V	500V	500V	
HP12(2512)	2W	$0.01\Omega \sim 10\text{M}\Omega$	300V	500V	500V	

Type	Resistance Value of Jumper	Rated Current of Jumper	Max. Overload Current of Jumper
HP02(0402)	$\leq 10\text{m}\Omega$	3A	6A
HP03(0603)	$\leq 8\text{m}\Omega$	5A	10A
HP05(0805)	$\leq 5\text{m}\Omega$	6A	12A
HP06(1206)	$\leq 5\text{m}\Omega$	10A	20A
HP07(1210)	$\leq 4\text{m}\Omega$	12A	24A
HP10(2010)	$\leq 5\text{m}\Omega$	12A	24A
HP11(1812)	$\leq 5\text{m}\Omega$	12A	24A
HP12(2512)	$\leq 5\text{m}\Omega$	16A	32A

7. Soldering pad size recommended

Type	Dimension(mm)			
	A	B	C	D
HP02	0.5±0.05	0.5±0.05	0.6±0.05	1.5±0.05
HP03	0.8±0.05	0.8±0.05	0.9±0.05	2.4±0.05
HP05	1.0±0.1	1±0.1	1.4±0.1	3±0.1
HP06	2.0±0.1	1.1±0.1	1.8±0.1	4.2±0.1
HP07	2.0±0.1	1.1±0.1	2.9±0.1	4.2±0.1
HP10	3.6±0.1	1.4±0.1	3±0.1	6.4±0.1
HP11	3.0±0.1	1.4±0.1	3.7±0.1	5.8±0.1
HP12	4.9±0.1	1.35±0.1	3.7±0.1	7.6±0.1



8. Derating Curve

Power rating will change based on continuous load at ambient temperature from -55 to 155°C.

It is constant between -55 to 70°C, and derate to zero when temperature rise from 70 to 155°C.

Voltage rating:

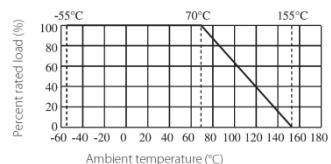
Resistors shall have a rated direct-current (DC) continuous working voltage or an approximate sine-wave root-mean-square (RMS) alternating-current (AC) continuous working voltage at commercial-line frequency and waveform corresponding to the power rating, as determined from the following formula:

$$RCWV = \sqrt{P \times R}$$

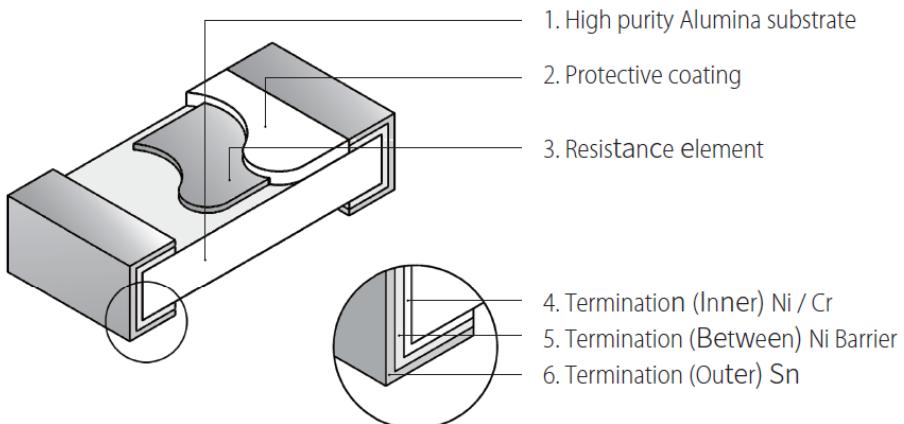
Remark: RCWV: Rating Continuous Working Voltage (Volt.) P: power rating (Watt) R: nominal resistance (Ω)

In no case shall the rated DC or RMS AC continuous working voltage be greater than the applicable maximum value.

The overload voltage is 2.5 times RCWV or Max. Overload voltage whichever is lower.



9. Structure



10. Performance Specification

Characteristic	Limits	Ref. Standards	Test Methods
Operational life	$\pm 0.5\%, \pm 1\%: \pm (1.0\% + 0.1\Omega)$ $\pm 5\%: \pm (3.0\% + 0.1\Omega)$	MIL-STD-202 Method 108	70°C rated power , at RCWV or Max .Working Voltage whichever less, 1000h (1.5 hours "ON", 0.5 hour "OFF"). Measurement at 24±4hours after test conclusion.
	HP02:<20m Ω ;HP03<16 m Ω ; HP05、HP06、HP10、HP11、HP12: <10 m Ω HP07:<8m Ω		Apply to rate current for 0 Ω
Electrical Characterization (T.C.R)	HP02: $1\Omega \leq R \leq 10\Omega: \pm 400 \text{ PPM/}^{\circ}\text{C}$ $10\Omega < R \leq 100\Omega: \pm 200 \text{ PPM/}^{\circ}\text{C}$ $100\Omega < R \leq 10M: \pm 100 \text{ PPM/}^{\circ}\text{C}$ HP03: $0.1\Omega \leq R < 0.2\Omega: \pm 200 \text{ PPM/}^{\circ}\text{C}$ $0.2\Omega \leq R \leq 10M: \pm 100 \text{ PPM/}^{\circ}\text{C}$	GB/T 5729 4.8 JIS-C-5201 4.8 IEC 60115-1 6.2	Natural resistance changes per temp. Degree centigrade $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (PPM/}^{\circ}\text{C)}$ R ₁ : Resistance Value at room temperature (t ₁) ;

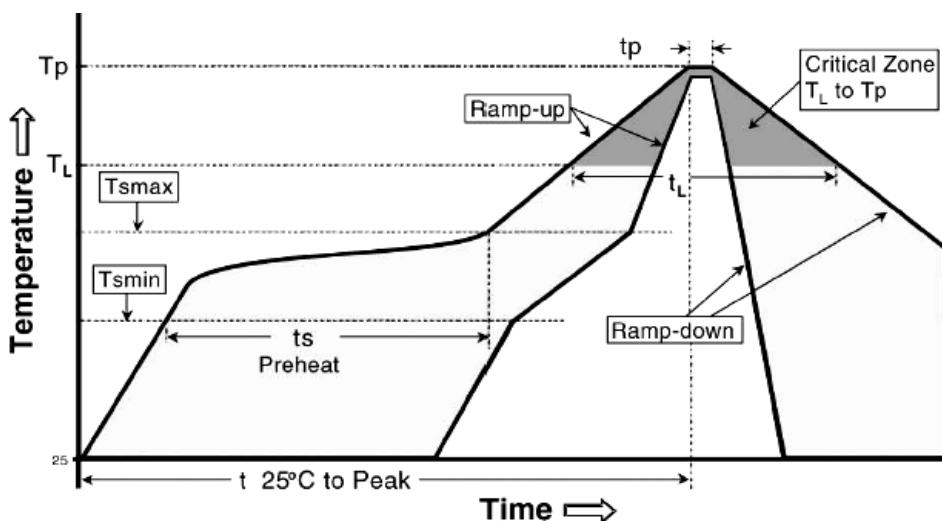
	HP05: 10mΩ≤R≤15mΩ: ±800ppm/°C 15mΩ≤R≤25mΩ: ±600ppm/°C 25mΩ≤R≤50mΩ: ±400ppm/°C 50mΩ≤R<0.1Ω: ±200ppm/°C 0.1Ω≤R≤10M: ±100ppm/°C HP06: 10mΩ≤R<15mΩ: ±700 ppm/°C 15mΩ≤R<30mΩ: ±400 ppm/°C 30mΩ≤R<50mΩ: ±300 ppm/°C 50mΩ≤R<0.1Ω: ±150 ppm/°C 0.1Ω≤R≤10M:±100 ppm/°C HP10: 10mΩ≤R<15mΩ: 0~+800 ppm/°C 15mΩ≤R<50mΩ: 0~+600 ppm/°C 50mΩ≤R<10M: ±100 ppm/°C HP07、HP11: ±100PPM/°C HP12: 10mΩ≤R<20mΩ: 0~+800ppm/°C 20mΩ≤R≤50mΩ: 0~+400ppm/°C 50mΩ≤R≤10M: ±100ppm/°C		R ₂ : Resistance at test temperature (t ₂) t ₁ : +25°C or specified room temperature t ₂ : Test temperature (-55°C or 125°C)
Short-time overload	±0.5%,±1%: ±(1.0%+0.1Ω) ±5%: ±(2.0%+0.1Ω) HP02: ≤10mΩ;HP03≤8 mΩ; HP05、HP06、HP10、HP11、HP12: ≤5mΩ HP07: ≤4mΩ	GB/T 5729 4.13 JIS-C-5201 4.13 IEC 60115-1 8.1.4.2	Permanent resistance change after the application of a potential of 2.5 times RCWV or Max. Overload Voltage whichever less for 5 seconds.. Apply max Overload current for 0Ω
External Visual	Marking Complete , no mechanical damage	MIL-STD-883 Method 2009	Electrical test not required. Inspect device construction, marking and workmanship
Physical Dimension	Reference 5 Dimension Standards	JESD22 MH Method JB-100	Verify physical dimensions to the applicable device detail specification. Note: User(s) and Suppliers spec. Electrical test not required.
Resistance to Solvent	Marking Complete , no mechanical damage	MIL-STD-202 Method 215	Note: Add Aqueous wash chemical – OKEM Clean or equivalent. Do not use banned solvents.
Terminal Strength	Not broken	AEC-Q200-006	HP02:5N; others:17.7N, 60±1 seconds.
High Temperature Exposure (Storage)	±0.5%,±1%: ±(1.0%+0.1Ω) ±5%: ±(3.0%+0.1Ω) HP02: ≤10mΩ;HP03≤8 mΩ; HP05、HP06、HP10、HP11、HP12: ≤5mΩ HP07: ≤4mΩ	MIL-STD-202 Method 108	Upper Temperature.1000hrs. Unpowered. Measurement at 24±4 hours after test conclusion.
Temperature Cycling	±(1.0%+0.05Ω) HP02: ≤10mΩ;HP03≤8 mΩ; HP05、HP06、HP10、HP11、HP12: ≤5mΩ HP07: ≤4mΩ	JESD22 Method JA-104	1000 Cycles (-55°C to +155°C). Measurement at 24±4 hours after test conclusion.
Biased Humidity	±0.5%,±1%: ±(1.0%+0.05Ω) ±5%: ±(3.0%+0.05Ω) HP02: ≤10mΩ;HP03≤8 mΩ; HP05、HP06、HP10、HP11、HP12: ≤5mΩ HP07: ≤4mΩ	MIL-STD-202 Method 103	1000 hours 85°C,85%RH. Note: Specified conditions: 10% of operating power. Measurement at 24±4 hours after test conclusion. Apply to rate current for 0 Ω
Mechanical Shock	±0.5%,±1%: ±(1.0%+0.1Ω) ±5%: ±(2.0%+0.1Ω) HP02: ≤10mΩ;HP03≤8 mΩ; HP05、HP06、HP10、HP11、HP12: ≤5mΩ HP07: ≤4mΩ	MIL-STD-202 Method 213	Half sine wave, acceleration 100g's, each three times in X, Y and Z directions, pulse width 6ms.

Vibration	±0.5%,±1%: ±(1.0%+0.1Ω) ±5%: ±(2.0%+0.1Ω)	MIL-STD-202 Method 204	5g's for 20 min., 12cycle each of 3 orientations. Note: Use 8"**5"PCB. 031" thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2' from any secure point. Test from 10-2000Hz.
	HP02: ≤10mΩ; HP03≤8 mΩ; HP05、HP06、HP10、HP11、HP12: ≤5mΩ HP07: ≤4mΩ		
ESD	±(3.0%+0.1Ω)	AEC-Q200-002	With the electrometer in direct contact with the discharge tip, verify the voltage setting at levels of ±500V,±1KV, ±2KV, ±4KV, ±8KV, The electrometer reading shall be within ±10% for voltages from 500V to ≤800V.
Solderability	Coverage must be over 95%.	J-STD-002	For both leaded & SMD. Electrical test not required. Magnification 50X. Conditions: a) Method B 4hrs at 155°C dry heat, the dip in bath with 245±3°C, 5±0.5s. b) Method D: at 260±3°C, 30±0.5s..
Flammability	No ignition of the tissue paper or scorching or the pinewood board	UL-94	V-0 or V-1 are acceptable. Electrical test not required.
Board Flex	±(1.0%+0.05Ω)	AEC-Q200-005	
	HP02: ≤10mΩ; HP03≤8 mΩ; HP05、HP06、HP10、HP11、HP12: ≤5mΩ HP07: ≤4mΩ		Bending 2mm(min) for 60+5sec
Flame Retardance	No flame	AEC-Q200-001	Only requested, when voltage/power will increase the surface temp to 350°C. Apply voltage from 9V to 32V. No flame; No explosion.
Resistance to Soldering Heat	±(1.0%+0.05Ω)	MIL-STD-202 Method 210	Condition B No per-heat of samples. Dipping the resistor into a solder bath having a temperature of 260°C±5°C and hold it for 10±1 seconds
	HP02: ≤10mΩ; HP03≤8 mΩ; HP05、HP06、HP10、HP11、HP12: ≤5mΩ HP07: ≤4mΩ		

11. Soldering Condition

(This is for recommendation, please customer perform adjustment according to actual application)

11.1 Recommend Reflow Soldering Profile : (solder : Sn96.5 / Ag3 / Cu0.5)

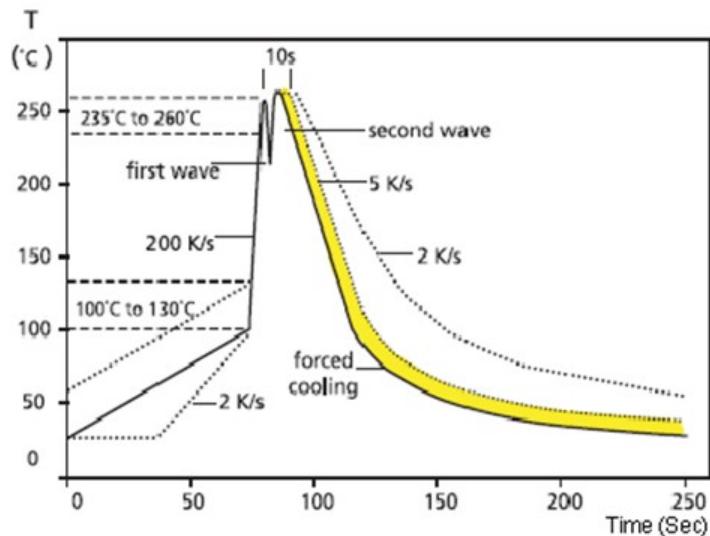


Profile Feature	Lead (Pb)-Free solder
Preheat:	
Temperature Min ($T_{s_{\min}}$)	150°C
Temperature Max ($T_{s_{\max}}$)	200°C
Time ($T_{s_{\min}}$ to $T_{s_{\max}}$) (ts)	60 -120 seconds
Average ramp-up rate : (T_s max to T_p)	3°C / second max.
Time maintained above :	
Temperature (T_L)	217°C
Time (t_L)	60-150 seconds
Peak Temperature (T_p)	260°C
Time within $^{+0}_{-5}$ °C of actual peak Temperature (t_p) ²	10 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8minutes max.

Allowed Re-flow times : 2 times

Remark : To avoid discoloration phenomena of chip on terminal electrodes, we suggest use N₂ Re-flow furnace .

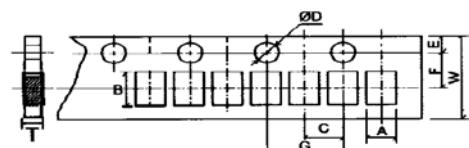
11.2 Recommend Wave Soldering Profile : (Apply to 0603 and above size)



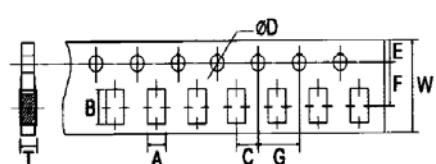
12. Packing

12.1 Dimension of Paper Taping :(Unit: mm)

Type	A ± 0.1	B ± 0.1	C ± 0.05	$\Phi D_{-0}^{+0.1}$	E ± 0.1	F ± 0.05	G ± 0.1	W ± 0.2	T ± 0.05
HP02	0.65	1.20	2.00	1.50	1.75	3.5	4.00	8.0	0.42

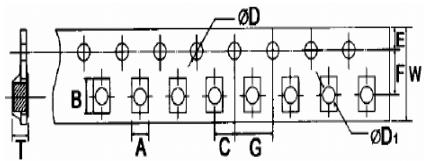


TYPE	A ± 0.2	B ± 0.2	C ± 0.05	$\Phi D_{-0}^{+0.1}$	E ± 0.1	F ± 0.05	G ± 0.1	W ± 0.2	T ± 0.10
HP03	1.10	1.90	2.00	1.50	1.75	3.5	4.00	8.00	0.67
HP05	1.65	2.40	2.00	1.50	1.75	3.5	4.00	8.00	0.81
HP06	2.00	3.60	2.00	1.50	1.75	3.5	4.00	8.00	0.81
HP07	2.80	3.50	2.00	1.50	1.75	3.5	4.00	8.00	0.75



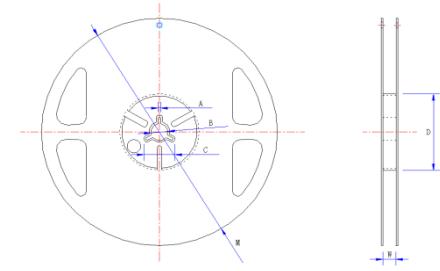
12.2 Dimension of plastic taping: (Unit: mm)

Type	A ±0.2	B ±0.2	C ±0.05	ΦD ^{+0.1} -0	ΦD1 ^{+0.25} -0	E ±0.1	F ±0.05	G ±0.1	W ±0.2	T ±0.1
HP10	2.9	5.6	2.0	1.5	1.5	1.75	5.5	4.0	12.0	1.0
HP11	3.5	4.8	2.0	1.5	1.5	1.75	5.5	4.0	12.0	1.0
HP12	3.5	6.7	2.0	1.5	1.5	1.75	5.5	4.0	12.0	1.0



12.3 Dimension of Reel : (Unit: mm)

Type	Taping	Qty/Reel	A±0.5	B±0.5	C±0.5	ΦD±1	ΦL±2	W±1
HP02	Paper	10,000pcs	2.0	13.0	21.0	60.0	178.0	10.0
HP03	Paper	5,000pcs	2.0	13.0	21.0	60.0	178.0	10.0
HP05	Paper	5,000pcs	2.0	13.0	21.0	60.0	178.0	10.0
HP06	Paper	5,000pcs	2.0	13.0	21.0	60.0	178.0	10.0
HP07	Paper	5,000pcs	2.0	13.0	21.0	60.0	178.0	10.0
HP10	Embossed	4,000pcs	2.0	13.0	21.0	60.0	178.0	13.8
HP11	Embossed	4,000pcs	2.0	13.0	21.0	60.0	178.0	13.8
HP12	Embossed	4,000pcs	2.0	13.0	21.0	60.0	178.0	13.8



13. Note

13.1. UNI-ROYAL recommend the storage condition temperature: 15°C~35°C, humidity :25%~75%.

(Put condition for individual product).Even under UNI-ROYAL recommended storage condition, solderability of products over 1 year old.
(Put condition for each product) may be degraded.

13.2. Store / transport cartons in the correct direction, which is indicated on a carton as a symbol.

Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.

13.3. Product performance and soldered connections may deteriorate if the products are stored in the following places:

- Storage in high Electrostatic.
- Storage in direct sunshine 、 rain and snow or condensation.
- Where the products are exposed to sea winds or corrosive gases, including Cl₂, H₂S₃ NH₃, SO₂, NO₂, Br etc.

14. Record

Version	Description	Page	Date	Amended by	Checked by
1	First version	1~8	May.22, 2020	Haiyan Chen	Yuhua Xu
2	1.Add 0603 Marking 2. Add 0Ω the greater than the Max Overload Curren 3. Modify terminal strength test conditions	3~4 4 6	Sep.19, 2022	Haiyan Chen	Yuhua Xu
3	Modify ESD test	7	Feb.19, 2024	Song Nie	Haiyan Chen
4	Modify temperature cycling test	5	Aug.10, 2024	Haiyan Chen	Yuhua Xu
5	The IEC60115 reference standard is modified	6	Oct.30, 2024	Haiyan Chen	Yuhua Xu
6	1.Add the ±0.5% tolerance 2.Modify the "W" dimension of HP07	2,4 4	Apr.17, 2025	Haiyan Chen	Yuhua Xu
7	Modify Performance Specification	6	Jan.08, 2026	Xiaoli Liu	Haiyan Chen

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